

RoHS H

M

# 465 Series Fuse



Agency Approvals		
AGENCY	AGENCY FILE NUMBER	AMPERE RANGE
PSE	NBK030205-E108480B	1A - 6.3A
М	E184655A,B	250mA - 6.3A

#### **Electrical Characteristics for Series**

% of Ampere Rating	OpeningTime
125%	1 hour, Minimum
200%	2 minutes, Maximum
1000%	0.01 sec., Min.; 0.1 sec., Max.

# **Electrical Specifications by Item**

# Description

The Surface Mount Nano<sup>2</sup> 250V UMF product family complies with IEC Publication IEC60127-4-Universal Modular Fuse-Links [UMF]. This IEC standard has been accepted world wide.

# Features

- Time-Lag
- Listed to IEC 60127-4, Universal Modular Fuse-Links (UMF), 250V
- 250VAC Voltage rating
- RoHS compliant and Halogen Free

# Applications

- Power supply
- Lighting system
- White goods
- Industrial equipment
- Medical equipment

**Additional Information** 







Samples

Ampere	Max		Nominal Cold		Agency Approvals		
Rating (A)	Amp Code	Voltage Rating (V)	Interrupting Rating	Resistance (Ohms)	Nominal Melting I²t (A²sec)	PSE	M
1.00	001.	250	100 amperes @250VAC	0.1070	2.8	х	х
1.25	1.25	250		0.0830	5.6	х	х
1.60	01.6	250		0.0560	9.2	Х	x
2.00	002.	250		0.0390	14.9	х	х
2.50	02.5	250		0.0260	21.0	Х	х
3.15	3.15	250		0.0210	31.7	х	х
4.00	004.	250		0.0160	48.4	Х	х
5.00	005.	250		0.0130	87.0	х	х
6.30	06.3	250		0.0088	144.4	х	х

Notes:

- l²t calculated at 8ms.

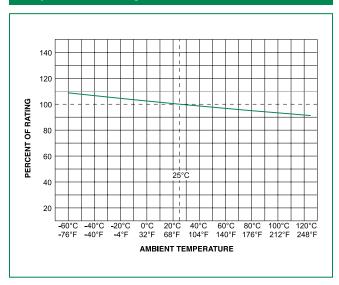
- Resistance is measured at 10% of rated current, 25°C

- For information and availability of additional ratings please contact Littelfuse



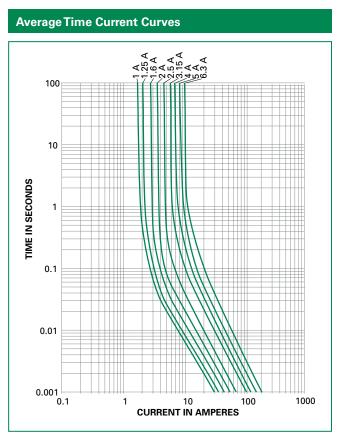
# **Surface Mount Fuses** NANO<sup>2®</sup> > 250V UMF Time Lag > 465 Series

## **Temperature Rerating Curve**



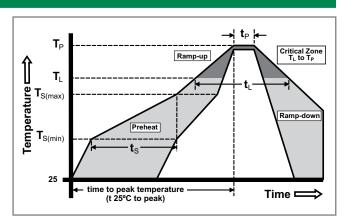
Note:

1. Derating depicted in this curve is in addition to the standard derating of 15% for continuous operation.



# **Soldering Parameters**

Reflow Condition		Pb – Free assembly	
	-Temperature Min (T <sub>s(min)</sub> )	150°C	
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	-Time (Min to Max) (t <sub>s</sub> )	60 – 120 secs	
Average ramp up rate (Liquidus Temp $(T_L)$ to peak		5°C/second max.	
T <sub>S(max)</sub> to T <sub>L</sub> - Ramp-up Rate		5°C/second max.	
Reflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
	-Temperature (t <sub>L</sub> )	60 – 90 seconds	
PeakTemperature (T <sub>P</sub> )		260+0/-5 °C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		20 – 40 seconds	
Ramp-down Rate		5°C/second max.	
Time 25°C to peak Temperature (T <sub>P</sub> )		8 minutes max.	
Do not exceed		260°C	
Wave Soldering Parameters		260°C Peak Temperature, 3 seconds max.	

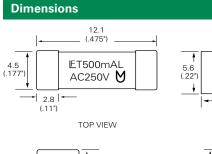




#### **Product Characteristics**

Materials	Body: High Performance Ceramic Terminations: Silver plated brass.
Product Marketing	Brand, Ampere Rating, Voltage Rating, UMF Logo
Operating Temperature	–55°C to 125°C.
Moisture Sensitivity Level	Level 1, J-STD-020C
Solderability	IEC60127-4
Insulation Resistance (after opening	IEC 60127-4 (0.1Mohm min @ 500VDC)
Shock	MIL-STD-202, Method 213, Test Condition A

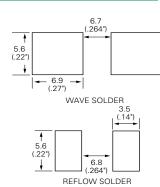
Thermal Shock	MIL-STD-202, Method 107, Test Condition B , 5 cycles, –65°C to 125°C
Mechanical Shock	MIL-STD-202, Method 213, Test Condition A
Vibration	MIL-STD-202, Method 201 (10-55 Hz)
Moisture Resistance	MIL-STD-202, Method 106, 10 cycles
Salt Spray	MIL-STD-202, Method 101, Test Condition B (48hrs)
Resistance to Soldering Heat	IEC 60127-4



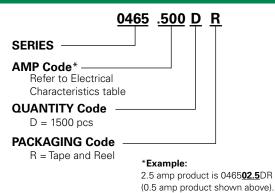
4.5

(.177")

END CAP



# Part Numbering System



# Packaging Packaging Option Packaging Specification Quantity Quantity & Packaging Code 24mm Tape and Reel EIA RS-481-1 (IEC 286, part 3) 1500 DR